

ABSTRACT OF THE DISCLOSURE

Embodiments of a heat dissipating structure and method for a mobile device can cool components of a mobile terminal. The heat-dissipating structure can include a case, a device mounted in the case that generates heat in connection with its operation, and a cooling unit. The cooling unit can include a housing having a refrigerant therein, a first heat exchanging part for absorbing the heat through a thermal contact with the device and a second heat exchanging part for dissipating the heat.